mail

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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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FIBER SENSORS

LASER SENSORS

PHOTOELECTRIC SENSORS

MICRO PHOTOELECTRIC SENSORS

AREA SENSORS LIGHT CURTAINS/ SAFETY COMPONENTS PRESSURE / FLOW SENSORS INDUCTIVE PROXIMITY SENSORS

SENSOR OPTIONS SIMPLE WIRE-SAVING UNITS WIRE-SAVING SYSTEMS

MEASUREMENT SENSORS

STATIC ELECTRICITY PREVENTION DEVICES LASER MARKERS

HUMAN MACHINE INTERFACES

ENERGY CONSUMPTION VISUALIZATION COMPONENTS

MACHINE VISION SYSTEMS

UV CURING SYSTEMS

Selection Guide Wafer Detection Liquid Leak Detection Water Detection Color Mark Detection Hot Melt Glue Detection

Ultrasonic Small / Slim Object Detection

Obstacle Detection

Other Products

PLC

Hot Melt Glue Detector

Related Information General terms and conditions...... F-7

■ Sensor selection guide......P.885~



Quick, non-contact detection of hot melt glue (infrared)

ORDER GUIDE

Туре	Appearance		Sensing range	Set model No.	Output
туре	Sensor head	Controller	Sensing range	Set model No.	Output
Spot			40 ±10 mm 1.575 ±0.394 in	TH-11CS	NPN open-collector transistor
Long sensing range	o			TH-12CS	NPN open-collector transistor
Long sens			10 to 300 mm 0.394 to 11.811 in (Note)	TH-12CPS	PNP open-collector transistor

Note: Teaching is possible for this sensing range.

However, the sensing range varies with the size of the sensing object and its temperature, ambient temperature, etc.

A sensor head and its respective controller comprise a set. Make sure to use the sensor head and the controller specified in the set model No. together as a set. [Please refer to "SPECIFICATIONS (p.946, 947)" for more details.]

SPECIFICATIONS

TH-11CS

h _

Sensor head		PHOTO- ELECTRIC SENSORS
Model No. Item	TH-11	MICRO PHOTO- ELECTRIC SENSORS
Applicable controller	TH-C1	AREA SENSORS
Sensing range	40 ±10 mm 1.575 ±0.394 in	LIGHT CURTAINS /
Sensing object	ø3 mm ø0.118 in or more hot melt glue (emissivity 0.9) at +85 °C +185 °F or more, under ambient temperature of +25 °C +77 °F (Note 2)	SAFETY COMPONENTS
Ambient temperature	0 to +50 °C +32 to +122 °F (No dew condensation), Storage: -10 to +60 °C +14 to +140 °F	PRESSURE / FLOW SENSORS
Visible targeting	Red LED	INDUCTIVE
Material	Enclosure: Polycarbonate, Front cover: Sapphire glass	SENSORS
Weight	Net weight: 77 g approx.	PARTICULAR USE SENSORS
Accessories	MS-TH-1 (Sensor head mounting bracket): 1 set, TH-B1 (Heat shield): 1 pc.	SENSOR
Notes: 1) Where measurement c	onditions have not been specified precisely, the conditions used were an ambient temperature of +20 °C, +68 °E	SENSOR OPTIONS

Notes: 1) Where measurement conditions have not been specified precisely, the conditions used were an ambient temperature of +20 °C +68 °F. 2) A hot melt drop at +60 °C +140 °F or higher can be detected if it is ø5 mm ø0.197 in or more.

Controller

	WIRE-SAVING SYSTEMS	
TH-C1	MEASURE MENT SENSORS	
TH-11	STATIC ELECTRICITY PREVENTION	
12 to 24 V DC ±10 % Ripple P-P 10 % or less	- <u>DEVICES</u>	
100 mA or less	MARKERS	
 NPN open-collector transistor Maximum sink current: 100 mA Applied voltage: 30 V DC or less (between output and 0 V) Residual voltage: 1 V or less (at 100 mA sink current) 0.4 V or less (at 16 mA sink current) 	PLC HUMAN MACHINE INTERFACES ENERGY	
OUT 1: ON when hot melt adhesive in detected (Max. 1 sec. approx.), OUT 2: ON when the evaluated result is NG (Max. 1 sec. approx.)	 CONSUMPTION VISUALIZATION COMPONENTS 	
1 ms or less (1 to 200 Hz)	FA COMPONENTS	
40 sec. approx.	MACHINE	
Teaching method (Push-button operation)	VISION SYSTEMS	
Sensitivity levels of eight channels can be stored.	- UV CURING - SYSTEMS	
Incorporated	- 5151EM5	
Incorporated with approx. 40 ms fixed OFF-delay timer, switchable either effective or ineffective	-	
0 to +50 °C +32 to +122 °F (No dew condensation), Storage: -10 to +60 °C +14 to +140 °F	-	
Enclosure: Heat-resistant ABS, Terminal cover: Heat-resistant ABS, Front cover: Polycarbonate		
ight Net weight: 200 g approx.		
	TH-11 12 to 24 V DC ±10 % Ripple P-P 10 % or less 100 mA or less NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less (between output and 0 V) • Residual voltage: 1 V or less (at 100 mA sink current) 0.4 V or less (at 16 mA sink current) 0UT 1: ON when hot melt adhesive in detected (Max. 1 sec. approx.), OUT 2: ON when the evaluated result is NG (Max. 1 sec. approx.) 1 ms or less (1 to 200 Hz) 40 sec. approx. Teaching method (Push-button operation) Sensitivity levels of eight channels can be stored. Incorporated Incorporated with approx. 40 ms fixed OFF-delay timer, switchable either effective or ineffective 0 to +50 °C +32 to +122 °F (No dew condensation), Storage: -10 to +60 °C +14 to +140 °F Enclosure: Heat-resistant ABS, Terminal cover: Heat-resistant ABS, Front cover: Polycarbonate	

Note: Where measurement conditions have not been specified precisely, the conditions used were an ambient temperature of +20 °C +68 °F.

FIBER SENSORS

LASER SENSORS

SIMPLE WIRE-SAVING UNITS

Spot type

SPECIFICATIONS

TH-12CS TH-12CPS

Sensor head

FIBER SENSORS

LASER SENSORS

PHOTO-ELECTRIC SENSORS

MICRO PHOTO-ELECTRIC SENSORS

AREA SENSORS

LIGHT CURTAINS / SAFETY COMPONENTS

PRESSURE / FLOW SENSORS

INDUCTIVE PROXIMITY SENSORS

SENSOR OPTIONS

SIMPLE WIRE-SAVING UNITS

WIRE-SAVING SYSTEMS

MEASURE-MENT SENSORS

Model No. Item	TH-12	
Applicable controllers	TH-C2, TH-C2P	
Sensing range	10 to 300 mm 0.394 to 11.811 in (Note 2)	
Sensing object	Ø6 mm Ø0.236 in (equivalent to 3 × 10 mm 0.118 × 0.394 in) or more hot melt glue (emissivity 0.9) at +100 °C +212 °F or more, under ambient temperature of +25 °C +77 °F	
Pollution degree	3 (Industrial environment)	
Ambient temperature	0 to +50 °C +32 to +122 °F (No dew condensation), Storage: -10 to +60 °C +14 to +140 °F	
Material	Enclosure: Polycarbonate, Indicator: Polycarbonate, Lens: Silicone	
Weight	Net weight: 120 g approx.	
Accessories	MS-TH-2 (Sensor head mounting bracket): 1 set, TH-B2 (Heat shield): 1 pc., OS-TH12 (Slit mask): 1 pc.	

Notes: 1) Where measurement conditions have not been specified precisely, the conditions used were an ambient temperature of +20 °C +68 °F. 2) Teaching is possible for this detection range. However, the detection range varies with the size of the sensing object and its temperature, ambient temperature, etc.

Controllers

\swarrow	Туре	NPN output (for TH-12CS)	PNP output (for TH-12CPS)		
Item	Model No.	TH-C2	TH-C2P		
Applic	able sensor head	TH-12			
Suppl	y voltage	12 to 24 V DC ±10 % Ripple P-P 10 % or less			
Curre	nt consumption	100 mA or less			
Outpu	its (OUT 1, OUT 2)	 NPN open-collector transistor Maximum sink current: 100 mA Applied voltage: 30 V DC or less (between output and 0 V) Residual voltage: 1 V or less (at 100 mA sink current) 0.4 V or less (at 16 mA sink current) 	 PNP open-collector transistor Maximum source current: 100 mA Applied voltage: 30 V DC or less (between output and +V) Residual voltage: 2 V or less (at 100 mA source current) 		
l	Utilization category		DC-12 or DC-13		
0	Output operation	eration OUT 1: ON when hot melt adhesive is detected (Max. 1 sec. approx.), OUT 2: OFF when the evaluated result is NG (
Respo	onse time (operation freq.)	Sensing distance 200 mm 7.874 in or less: 1 ms or less (1 to 200 Hz), Sensing distance 300 mm 11.811 in or less: 1.5 ms or less (1 to 100 Hz)			
Warm	-up time	40 sec. approx.			
Sensit	tivity setting	Teaching method (Push-button operation)			
Level	storage function	Sensitivity levels of eight channels can be stored.			
External channel select function		Incorporated			
Timer	function	Incorporated with approx. 40 ms fixed OFF-delay timer, switchable either effective or ineffective			
Polluti	ion degree		3 (Industrial environment)		
Ambient temperature		0 to +50 °C +32 to +122 °F (No dew condensation), Storage: -10 to +60 °C +14 to +140 °F			
EMC			EN 60947-5-2		
Material		Enclosure: Heat-resistant ABS, Terminal cover: Heat-resistant ABS, Front cover: Polycarbonate			
Weigh	nt	Net weight: 200 g approx.	Net weight: 140 g approx.		

Note: Where measurement conditions have not been specified precisely, the conditions used were an ambient temperature of +20 °C +68 °F.

PRECAUTIONS FOR PROPER USE

- Never use this product as a sensing device for personnel protection.
- In case of using sensing devices for
- personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.

Refer to p.1501 for general precautions.

Wafer Detection Liquid Leak Detection Liquid Level Detection Water Detection

Color Mark Detection Hot Melt Glue

Ultrasonic Small / Slim Object Detection Obstacle Detection

Other Products

I/O CIRCUIT AND WIRING DIAGRAMS

NPN output type

I/O circuit diagram

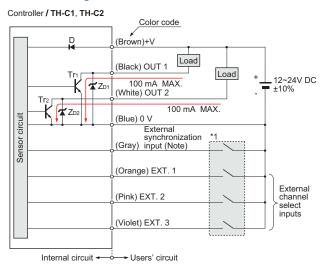
PNP output type I/O circuit diagram

Tr₂

Controller / TH-C2P

Tr

Sensor circuit



Note: The external synchronization input is active Low.

Symbols D: Revers	se supply polarity protection diode
ZD1, ZD2	: Surge absorption zener diode
Tr1, Tr2	: NPN output transistor

Color code

100 mA max

100 mA max

Load

* 2

Load

12 to 24 V DC ±10 %

External

channel select

inputs

(Brown) +V

(Black) OUT1

(White) OUT2

(Orange) EXT.1

(Pink) EXT.2

(Violent) EXT.3

Internal circuit - Users' circuit

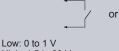
Note: The external synchronization input is active High.

Symbols ... D: Reverse supply polarity protection diode

(Blue) 0 V External synchronization (Gray) input (Note)

ŻΕ

Non-voltage contact or NPN open-collector transistor



High: 4.5 to 30 V, or open

*1

Specifying channel with external channel select inputs

Input Channel No.	EXT.1 (Orange)	EXT.2 (Pink)	EXT.3 (Violet)
1	L	Н	Н
2	Н	L	Н
3	L	L	Н
4	Н	Н	L
5	L	Н	L
6	Н	L	L
7	L	L	L
8	Н	Н	Н

L: Low (0 to 1 V), H: High (4.5 to 30 V, or open)

Notes: 1) The channel can be specified from the front panel only when all external channel

- select inputs (EXT.1, EXT.2, and EXT.3) are High (corresponding to Channel No. 8). 2) The external channel select inputs take precedence over the front panel channel selection (except for Channel No. 8).
- 3) If channel specification is changed from front panel operation to external channel select inputs and Channel No. 8 is to be selected by the external channel call inputs, make sure to specify a channel other than No. 8 before setting all the external channel select inputs (EXT 1 EXT 2 EXT 3) to High

If this operation is not done, channel specification by front panel operation gets precedence.

Specifying channel with external channel select inputs

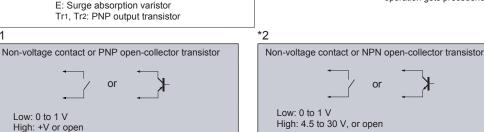
Input Channel No.	EXT.1 (Orange)	EXT.2 (Pink)	EXT.3 (Violet)
1	L	Н	Н
2	Н	L	Н
3	L	L	н
4	Н	Н	L
5	L	Н	L
6	Н	L	L
7	L	L	L
8	Н	Н	Н
L: Low (0 to 1 V), H: High	n (4.5 to 30 V, or o	open)	
(corresponding) 2) The external cha	I select inputs (EX to Channel No. 8). annel select inputs election (except for	T.1, EXT.2, and E take precedence r Channel No. 8).	XT.3) are High over the front

external channel select inputs and Channel No. 8 is to be selected by the external channel call inputs, make sure to specify a channel other than No. 8 before setting all the external channel select inputs (EXT.1, EXT.2, EXT.3) to High.

If this operation is not done, channel specification by front panel operation gets precedence.

Color Mark Detection Hot Melt Gl Ultrasonic Small / Slim Object Detection

Obstacle Detection Other Products



FLOW SENSORS INDUCTIVE PROXIMITY SENSORS

FIBER SENSORS

LASER SENSORS

PHOTO

ELECTRIC

MICRO PHOTO-ELECTRIC SENSORS

AREA SENSORS

LIGHT CURTAINS / SAFETY COMPONENTS

PRESSURE /

SENSOR OPTIONS SIMPLE WIRE-SAVING UNITS

WIRE-SAVING SYSTEMS MEASURE-MENT SENSORS

STATIC ELECTRICITY PREVENTION DEVICES LASER MARKERS

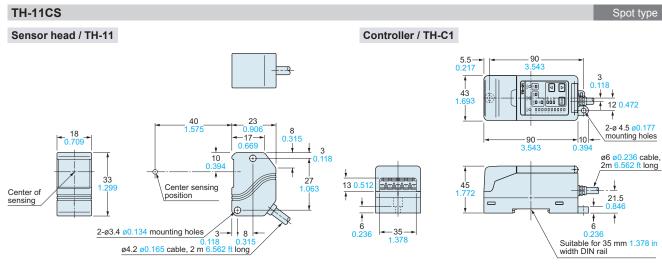
PLC

HUMAN MACHINE INTERFACES ENERG CONSUMPTIC VISUALIZATIC COMPONENT

> FA COMPONENTS MACHINE VISION SYSTEMS

UV CURING SYSTEMS

Selection Guide Wafer Detection Liquid Leak Detection Liquid Level Water Detection DIMENSIONS (Unit: mm in)



TH-12CS TH-12CPS

Sensor head /TH-12

ø21 ø0.827 lens aperture

Center of sensing

OUT 1 operation indicator (Red) 9

3 0.118

7 0.27

±t 1.6

0.063

34 1.339

13 0.512

. Ť<u>↓</u>

6

0.236

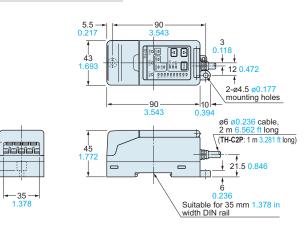
-30

 ϕ

0

1.181 15 - 15

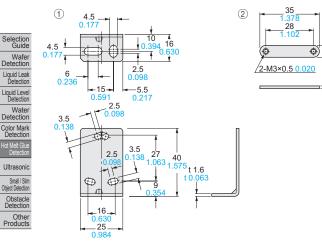
Controller /TH-C2 TH-C2P



Long sensing range type

The CAD data in the dimensions can be downloaded from our website.

MS-TH-1



25

16

0.630

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2-ø3.4 🤇

mounting holes

40

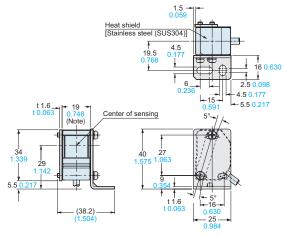
ø5 ø0.197 cable, 2 m 6.562 ft long,

0.9

Material: Cold rolled carbon steel (SPCC) Two M3 (length 25 mm 0.984 in) screws with washers are attached. Sensor head mounting bracket for spot type (Accessory for **TH-11**)

Assembly dimensions

The drawing below shows MS-TH-1 mounted on TH-11 fitted with heat shield TH-B1 (accessory).



Note: 18 mm 0.709 in when the heat shield is not used.

DIMENSIONS (Unit: mm in)

14.2

The CAD data in the dimensions can be downloaded from our website.

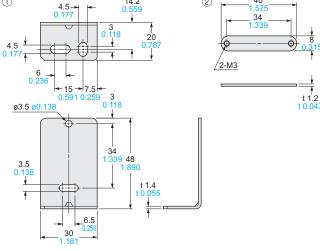
MS-TH-2

1

Sensor head mounting bracket for long sensing range type (Accessory for **TH-12**)



The drawing below shows MS-TH-2 mounted on TH-12 fitted with heat shield TH-B2 (accessory)



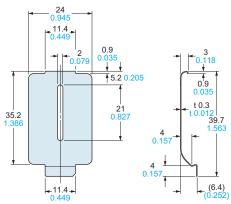
2

40

Material: Cold rolled carbon steel (SPCC)

Two M3 (length 30 mm 1.181 in) screws with washers are attached.

OS-TH12



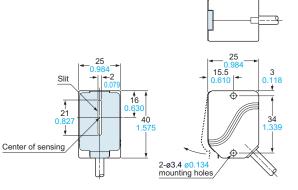
Material: Stainless steel (SUS304)

Heat shield [Stainless steel (SUS304)] 27 20 0 Ŧ 45 0.177 6 Center of -4.5 0.23 sensing 15 7.5 ____26 (Note) t 1.2 t 0.047 ٢ 34 .339 40 40 48 32 ⊛ 11 8 0.315 (47.4) 30 t 1.4

Note: 25 mm 0.984 in when the heat shield is not used.

Slit mask for long sensing range type (Accessory for TH-12)

Assembly dimensions



PLC HUMAN MACHINE INTERFACES ENERGY CONSUMPTION VISUALIZATION COMPONENTS FA COMPONENTS MACHINE VISION SYSTEMS UV CURING SYSTEMS

950

FIBER SENSORS

LASER SENSORS

PHOTO-ELECTRIC SENSORS

MICRO PHOTO-ELECTRIC SENSORS

AREA SENSORS

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